



Dear Valued Customer

Doc. No.: 2223001
Issue date: March 1, 2023

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General Manager

High Power Device Division
Power Discrete Headquarters
ROHM Co., Ltd.

Notification of Product/Process Change

This is an announcement of change(s) to the process of the products currently supplied by ROHM Co., Ltd.

We request your acknowledgement of the receipt of this notification within the given period.

Please provide your your reply by April 1st , 2024

Title of change	IGBT IPM & MOS IPM additional approval OSAT(Outsourced Semiconductor Assembly and Test)		
Affected product(s)	Manufacturer part number		Customer part number
	BM63967S-VA, BM64375S-VA, BM64377S-VA, BM60203S-VA, BM60303S-VA		See Attached Email
Detailed description of change	Now		After
	Assembly factory: ROHM INTEGRATED SYSTEMS (THAILAND) CO., LTD.		Assembly factory: •ROHM INTEGRATED SYSTEMS (THAILAND) CO., LTD. •GEM Electronics Co., Ltd. (SHANGHAI, CHAINA)
Reason for change	In order to increase the IPM production capacity		
Anticipated impact on quality	There is no difference and influence in electrical charecteristics and reliability level. (report in the attached file)		
Identification of change	It can be identified by part number, package outline, marking and lot number.		
Planned first ship date :		April 1, 2024	Sample available schedule : April 1, 2023
Attachments (data, report)		yes 4M 2223001-2_4ME	Rbl 2223001-3_Rbl
Comments	*Samples : Within 3 weeks from request		

		Reply date	
Customer reply	<input type="checkbox"/> 1. Approved. <input type="checkbox"/> 2. Accepted with conditions.		
Condition for approval / reason for rejection			
Comments			
Customer company name			
Customer signature		Department	
Customer signature		Department	